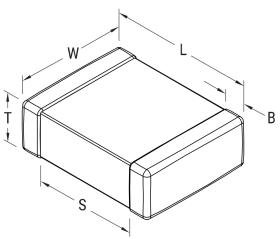


C2220X111FCGAL7210

SMD Comm COG HV Flex, Ceramic, 110 pF, 1%, 500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 2220



Click here for the 3D model.

Dimensions	
Chip Size	2220
L	5.9mm +/-0.75mm
W	5mm +/-0.4mm
Т	1.6mm +/-0.20mm
S	3.5mm MIN
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

SMD Comm COG HV Flex
SMD Chip
SMD, MLCC, FT-CAP, Ultra-Stable
FT-CAP, Ultra-Stable
No
▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
Flexible Termination With Lead (SnPb)
false
No
190 mg
78 Weeks
1

Specifications	
Capacitance	110 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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